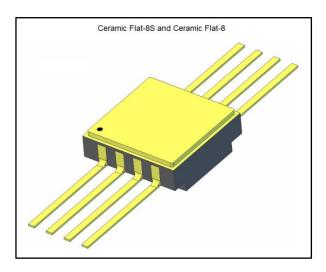


Rad-hard 550 MHz low noise operational amplifier

Datasheet - production data



Features

- Bandwidth: 550 MHz (unity gain)
- Quiescent current 4 mA
- Slew rate: 940 V/µs
- Input noise: 1.5 nV/√ Hz
- Distortion: SFDR = -66 dBc (10 MHz, 1 V_{pp})
- 2.8 V_{pp} minimum output swing on a 100 Ω load for a 5 V supply
- 5 V power supply
- ELDRS free up to 300 krad

- SEL immune at 110 MeV.cm²/mg
- SET characterized

Applications

- Space data acquisition systems
- Aerospace instrumentation
- Harsh environments
- ADC drivers

Description

The RHF350, RHF350A device is a current feedback, single operational amplifier that uses very high-speed complementary technology to provide a bandwidth of up to 550 MHz while drawing only 4 mA of quiescent current. With a slew rate of 940 V/µs and an output stage optimized for driving a standard 100 Ω load, this circuit is highly suitable for applications where speed and power-saving are the main requirements. The RHF350 is mounted in a Flat-8 hermetic package with 3 mm leads (Flat-8S) and the RHF350A is mounted in a Flat-8 hermetic package with 8 mm leads (Flat-8).

Table 1: Device summary

Parameter	RHF350K1	RHF350K1 RHF350K-01V R		RHF350AK01V			
SMD (1)	— 5962F07232		—	5962F07232			
Quality level	Engineering model	QML-V flight	Engineering model	QML-V flight			
Package and mass	Flat-8S, 0).45 g	Flat-8, 0.45 g				
EPPL ⁽²⁾	—	Yes	_	Yes			
Temp. range	-55 °C to 125 °C						

Notes:

⁽¹⁾SMD: standard microcircuit drawing

⁽²⁾EPPL = European preferred part list

This is information on a product in full production.

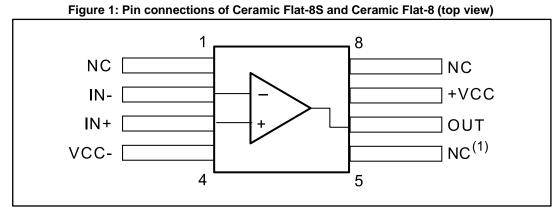
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1 Pin description



1. In the case of the Ceramic Flat-8, the upper metallic lid is electrically connected to pin 5



2

Absolute maximum ratings and operating conditions

Table 2: Absolute maximum ratings								
Symbol	Paramete	Value	Unit					
V _{cc}	Supply voltage (voltage difference between -Vcc	6						
V _{id}	Differential input voltage ⁽²⁾		±0.5	V				
Vin	Input voltage range (3)		±2.5					
T _{stg}	Storage temperature		-65 to 150	- °C				
Tj	Maximum junction temperature	150						
Rthja	Thermal resistance junction to a	150	°C/W					
Rthjc	Thermal resistance junction to ca	22						
P _{max}	Maximum power dissipation ⁽⁴⁾ (at $T_{amb} = 25 \text{ °C}$) for $T_j = 150 \text{ °C}$	830	mW					
	LIDM: human hady madel (5)	Pins 1, 4, 5, 6, 7 and 8	2					
	HBM: human body model ⁽⁵⁾	Pins 2 and 3	0.5	– kV				
	MM: machine model ⁽⁶⁾	Pins 1, 4, 5, 6, 7 and 8	200					
ESD		Pins 2 and 3	60	V				
	CDM: charged device model (7)	Pins 1, 4, 5, 6, 7 and 8	1.5	kV				
	CDM: charged device model ⁽⁷⁾	1.5	ĸv					
	Latch-up immunity		200	mA				

Notes:

⁽¹⁾All voltage values are measured with respect to the ground pin.

⁽²⁾The differential voltage is the non-inverting input terminal with respect to the inverting input terminal.

 $^{(3)}$ The magnitude of the input and output voltage must never exceed V_{CC} + 0.3 V.

⁽⁴⁾Short-circuits can cause excessive heating. Destructive dissipation can result from short circuits on amplifiers.

 $^{(5)}$ Human body model: a 100 pF capacitor is charged to the specified voltage, then discharged through a 1.5 k Ω resistor between two pins of the device. This is done for all couples of connected pin combinations while the other pins are floating.

⁽⁶⁾This is a minimum value. Machine model: a 200 pF capacitor is charged to the specified voltage, then discharged directly between two pins of the device with no external series resistor (internal resistor < 5 Ω). This is done for all couples of connected pin combinations while the other pins are floating.

⁽⁷⁾Charged device model: all pins and package are charged together to the specified voltage and then discharged directly to ground through only one pin. This is done for all pins.



Symbol	Parameter	Value	
Vcc	Supply voltage	4.5 to 5.5	V
Vicm	Common-mode input voltage	-Vcc + 1.5 V to Vcc - 1.5 V	V
Tamb	Operating free-air temperature range (1)	-55 to 125	°C

Notes:

 $^{(1)}Tj$ must never exceed 150 °C. P = (Tj - Tamb / Rthja = (Tj - Tcase) / Rthjc where P is the power that the RHF350, RHF350A must dissipate in the application.



3 Electrical characteristics

Table 4: Electrical characteristics for $V_{CC} = \pm 2.5 \text{ V}$, $T_{amb} = 25 \text{ °C}$ (unless otherwise specified)

Symbol	Parameter		Test conditions ⁽¹⁾		Тур.	Max.	Unit	
DC perfo	rmance							
			125 °C	-4	1	4		
Vio	Input offset voltage		25 °C	-4	0.4	4	mV	
			-55 °C	-4	0.8	4		
			125 °C		8.5	35		
I _{ib+}	Non-inverting input bias current		25 °C		9	35		
			-55 °C		9	35		
			125 °C		2.5	25	μA	
I _{ib-}	Inverting input bias current		25 °C		2	20		
			-55 °C		1.8	25		
			125 °C	50	55			
CMR	Common mode rejection ratio, 20 log ($\Delta V_{ic}/\Delta V_{io}$)	$\Delta V_{ic} = \pm 1 V$	25 °C	54	57			
			-55 °C	50	58			
			125 °C	55	87		dB	
SVR	Supply voltage rejection ratio, 20 log ($\Delta V_{CC}/\Delta V_{io}$)	ΔV_{CC} = 3.5 V to 5 V	25 °C	68	87		uв	
			-55 °C	55	88			
PSRR	Power supply rejection ratio, 20 log ($\Delta V_{CC}/\Delta V_{out}$)	$\Delta V_{CC} = 200 \text{ mV}_{pp} \text{ at}$ 1 kHz	25 °C		51		1	
			125 °C		3.8	4.9		
Icc	Supply current	No load	25 °C		4	4.9	mA	
		-55 °C			4	4.9		
Dynamic	performance and output character	istics						
			125 °C	150	244			
Rol	Transimpedance	$\Delta V_{out} = \pm 1 V,$ R _L = 100 Ω	25 °C	170	260		kΩ	
		NL - 100 12	-55 °C	150	276			
		R _L = 100 Ω, A _V = 1	25 °C		550			
		R _L = 100 Ω, A _V = 2	25 °C		390			
		R_L = 100 Ω , A_V = 10	25 °C		125			
Bw	Small signal -3 dB bandwidth		125 °C	250	380		MHz	
	oniali signal -5 ub banuwiutit	RHF350, R _L = 100 Ω, A _V = -2	25 °C	250	425			
		∩v = -∠	-55 °C	250	466		1	
		RHF350A, R∟ = 100 Ω, A∨ = -2	25 °C		425			
SR	Slew rate ⁽²⁾	$\label{eq:Vout} \begin{split} V_{out} &= 2 \; V_{pp}, \; A_V = 2, \\ R_L &= 100 \; \Omega \end{split}$	25 °C	700	940		V/µs	



Electrical characteristics

Symbol	Parameter	Test conditions	(1)	Min.	Тур.	Max.	Unit
			125 °C	1.3	1.6		
V _{OH}	High level output voltage	R _L = 100 Ω	25 °C	1.44	1.55		
			-55 °C	1.3	1.5		V
			125 °C		-1.6	-1.3	v
V _{OL}	Low level output voltage	R _L = 100 Ω	25 °C		-1.55	-1.44	
			-55 °C		-1.5	-1.3	
		Output to GND	125 °C	135	210		
I _{sink}	Output sink current		25 °C	135	225		
			-55 °C	135	225		
	Output source current	Output to GND	125 °C		-200	-140	mA
I _{source}			25 °C		-225	-140	
			-55 °C		-240	-140	

Notes:

 $^{(1)}T_{min}$ < T_{amb} < T_{max} : worst case of the parameter on a standard sample across the temperature range. The evaluation is done on 50 units in the SO8 plastic package.

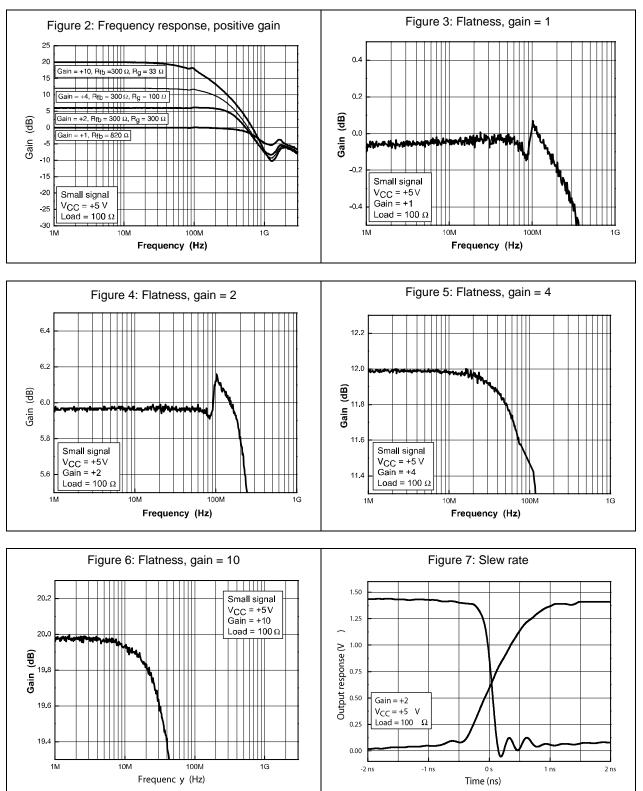
⁽²⁾ Guaranteed by characterization of initial design release and upon design or process changes which affect this parameter.

Table 5: Closed-loop gain and feedback components

Gain (V/V)	+ 1	- 1	+ 2	- 2	+ 10	- 10
R _{fb} (Ω)	820	300	300	300	300	300



4 Electrical characteristic curves



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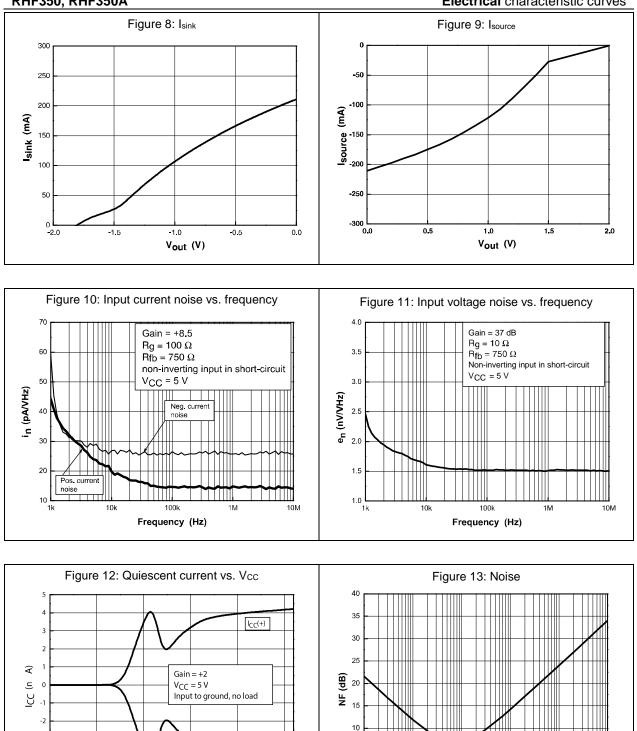
-5 L 0.0

0.5

1.0

1.5 V_{CC} (V)

Electrical characteristic curves



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5

0

10

100

 $\mathbf{R}_{\mathbf{source}}\left(\Omega\right)$

1k

I_{CC}(-)

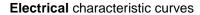
2.5

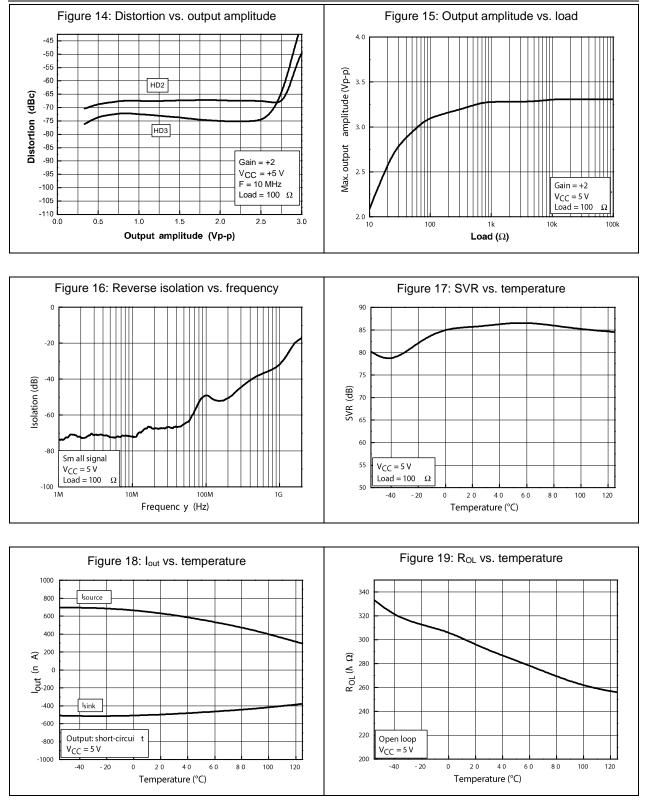
2.0

100k

V_{CC} = 5 V

10k

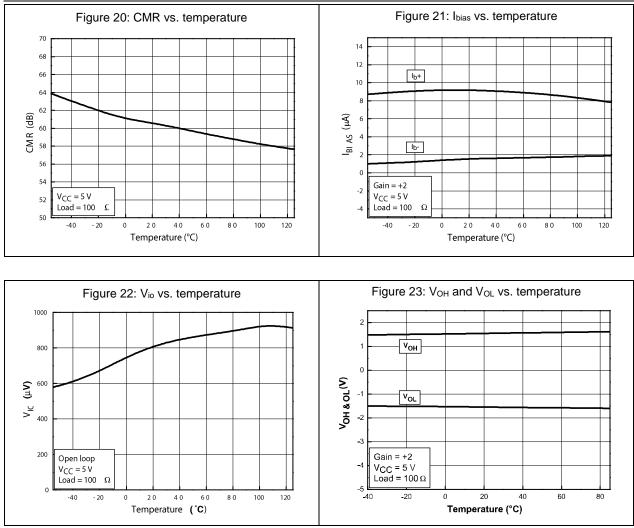


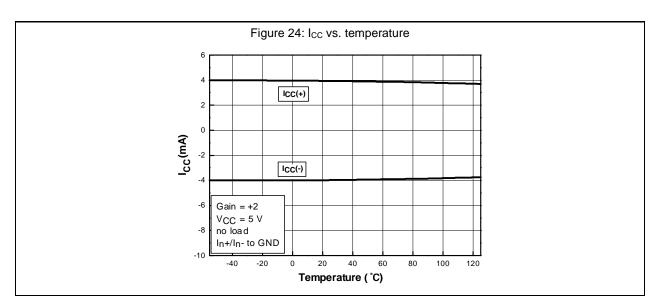


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Electrical characteristic curves





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5 Radiations

5.1 Introduction

Table 6 summarizes the radiation performance of the RHF350, RHF350A.

Туре	Features		Value	Unit				
	High-dose rate		300					
TID	Low-dose rate		300	krad				
	ELDRS		300					
	SEL immunity (at 125 °C) up to:	110	MeV.cm²/mg				
		Inverting	$LET_{th} = 19$	MeV.cm ² /mg				
		Inverting	σ = 4.00E-06	cm²/device				
Heavy ions	SET characterized	Non invorting	$LET_{th} = 18$	MeV.cm ² /mg				
	SET characterized	Non-inverting	σ = 2.00E-06	cm²/device				
		Subtracting	$LET_{th} = 1$	MeV.cm ² /mg				
		Subiraciling	σ = 6.00E-04	cm²/device				

Table 6: Radiations

5.2 Total ionizing dose (TID)

The products guaranteed in radiation within the RHA QML-V system fully comply with the MIL-STD-883 test method 1019 specification.

The RHF350, RHF350A is RHA QML-V qualified, and is tested and characterized in full compliance with the MIL-STD-883 specification. It uses a mixed bipolar and CMOS technology and is tested both below 10 mrad/s (low dose rate) and between 50 and 300 rad/s (high dose rate).

- The ELDRS characterization is performed in qualification only on both biased and unbiased parts, on a sample of ten units from two different wafer lots.
- Each wafer lot is tested at high-dose rate only, in the worst bias case condition, based on the results obtained during the initial qualification.

5.3 Heavy ions



The heavy ion trials are performed on qualification lots only. No additional test is performed.



6 Device description and operation

6.1 **Power supply considerations**

Correct power supply bypassing is very important for optimizing the performance of the device in high-frequency ranges. The bypass capacitors should be placed as close as possible to the IC pins to improve high-frequency bypassing. A capacitor greater than 1 μF is necessary to minimize the distortion. For better quality bypassing, a capacitor of 10 nF can be added, which should also be placed as close as possible to the IC pins. The bypass capacitors must be incorporated for both the negative and positive supply.

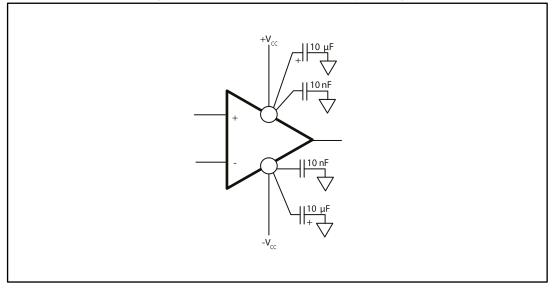


Figure 25: Circuit for power supply bypassing



6.1.1 Single power supply

If you use a single-supply system, biasing is necessary to obtain a positive output dynamic range between the 0 V and V_{CC} supply rails. Considering the values of V_{OH} and V_{OL}, the amplifier provides an output swing from 0.9 V to 4.1 V on a 100 Ω load.

The amplifier must be biased with a mid-supply (nominally V_{CC}/2) in order to maintain the DC component of the signal at this value. Several options are possible to provide this bias supply, such as a virtual ground using an operational amplifier or a two-resistance divider (which is the cheapest solution). A high resistance value is required to limit the current consumption. On the other hand, the current must be high enough to bias the non-inverting input of the amplifier. If we consider this bias current (35 μ A maximum) as 1 % of the current through the resistance divider, two resistances of 750 Ω can be used to maintain a stable mid-supply.

The input provides a high-pass filter with a break frequency below 10 Hz, which is necessary to remove the original 0 V DC component of the input signal and to set it at $V_{CC}/2$.

Figure 26 illustrates a 5 V single power supply configuration.

A capacitor C_G is added in the gain network to ensure a unity gain at low frequencies to keep the right DC component at the output. C_G contributes to a high-pass filter with $R_{fb}//R_G$ and its value is calculated with regard to the cut-off frequency of this low-pass filter.

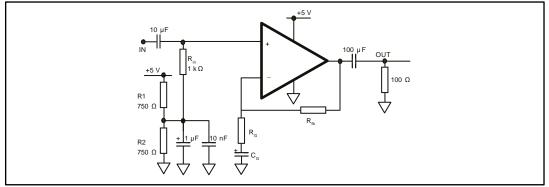
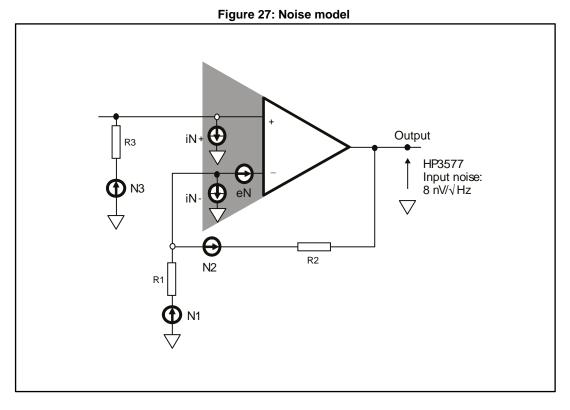


Figure 26: Circuit for 5 V single supply

6.2 Noise measurements

The noise model is shown in Figure 27.

- eN: input voltage noise of the amplifier
- iNn: negative input current noise of the amplifier
- iNp: positive input current noise of the amplifier



The thermal noise of a resistance R is:

$\sqrt{4kTR}$ F

Where ΔF is the specified bandwidth, and k is the Boltzmann's constant, equal to 1,374.10-23J/°K. T is the temperature (°K).

On a 1 Hz bandwidth the thermal noise is reduced to:

 $\sqrt{4kTR}$

The output noise eNo is calculated using the superposition theorem. However, eNo is not the simple sum of all noise sources but rather the square root of the sum of the square of each noise source, as shown in *Equation 1*.

Equation 1

$$eNo = \sqrt{V1^2 + V2^2 + V3^2 + V4^2 + V5^2 + V6^2}$$



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Equation 2

$$eNo^{2} = eN^{2} \cdot g^{2} + iNn^{2} \cdot R2^{2} + iNp^{2} \cdot R3^{2} \cdot g^{2} + \frac{R2^{2}}{R1} \cdot 4kTR1 + 4kTR2 + 1 \frac{R2^{2}}{R1} \cdot 4kTR3 + \frac{R2^{2}}{R1} \cdot 4kTR3 + \frac{R2^{2}}{R1} \cdot 4kTR3 + \frac{R2^{2}}{R1} \cdot \frac{R2^{2}}$$

The input noise of the instrumentation must be extracted from the measured noise value. The real output noise value of the driver is shown in *Equation 3*.

Equation 3

 $eNo = \sqrt{(Measured)^2 - (instrumentation)^2}$

The input noise is called **equivalent input noise** because it is not directly measured but is evaluated from the measurement of the output divided by the closed loop gain (eNo/g).

After simplification of the fourth and fifth terms of Equation 2, you obtain Equation 4.

Equation 4

$$eNo^2 = eN^2 \cdot g^2 + iNn^2 \cdot R2^2 + iNp^2 \cdot R3^2 \cdot g^2 + g \cdot 4kTR2 + 1 \quad \frac{R2^2}{R1} \cdot 4kTR3$$

6.2.1 Measurement of the input voltage noise eN

Assuming a short-circuit on the non-inverting input (R3 = 0), from *Equation 4* you can derive *Equation 5*.

Equation 5

$$eNo = \sqrt{eN^2 \cdot g^2 + iNn^2 \cdot R2^2 + g \cdot 4kTR2}$$

To easily extract the value of eN, the resistance R2 must be as low as possible. On the other hand, the gain must be high enough. R3 = 0 and gain (g) = 100.

6.2.2 Measurement of the negative input current noise iNn

To measure the negative input current noise iNn, R3 is set to zero and *Equation 5* is used. This time, the gain must be lower in order to decrease the thermal noise contribution. R3 = 0 and gain (g) = 10.

6.2.3 Measurement of the positive input current noise iNp

To extract iNp from *Equation 3*, a resistance R3 is connected to the non-inverting input. The value of R3 must be selected so that its thermal noise contribution is as low as possible against the iNp contribution. $R3 = 100 \Omega$ and gain (g) = 10.



6.3 Intermodulation distortion product

The non-ideal output of the amplifier can be described by the following series of equations.

$$V_{out} = C_0 + C_1 V_{in} + C_2 V_{in}^2 + ... + C_n V_{in}^n$$

Where the input is V_{in} = Asin ϖ t, C₀ is the DC component, C₁(V_{in}) is the fundamental and C_n is the amplitude of the harmonics of the output signal V_{out}.

A one-frequency (one-tone) input signal contributes to harmonic distortion. A two-tone input signal contributes to harmonic distortion and to the intermodulation product.

The study of the intermodulation and distortion for a two-tone input signal is the first step in characterizing the driving capability of multi-tone input signals.

In this case:

$$V_{in} = A \sin \omega_1 t + A \sin \omega_2 t$$

Therefore:

$$V_{out} = C_0 + C_1 (A \sin\omega_1 t + A \sin\omega_2 t) + C_2 (A \sin\omega_1 t + A \sin\omega_2 t)^2 + C_n (A \sin\omega_1 t + A \sin\omega_2 t)^n$$

From this expression, we can extract the distortion terms and the intermodulation terms from a single sine wave.

- Second-order intermodulation terms IM2 by the frequencies $(\omega_1 \omega_2)$ and $(\omega_1 + \omega_2)$ with an amplitude of C2A².
- Third-order intermodulation terms IM3 by the frequencies (2ω1-ω2), (2ω1+ω2), (-ω1+2ω2) and (ω1+2ω2) with an amplitude of (3/4)C3A³.

The intermodulation product of the driver is measured by using the driver as a mixer in a summing amplifier configuration (*Figure 28*). In this way, the non-linearity problem of an external mixing device is avoided.

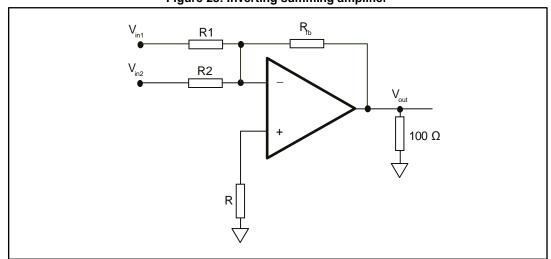


Figure 28: Inverting summing amplifier

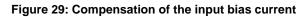


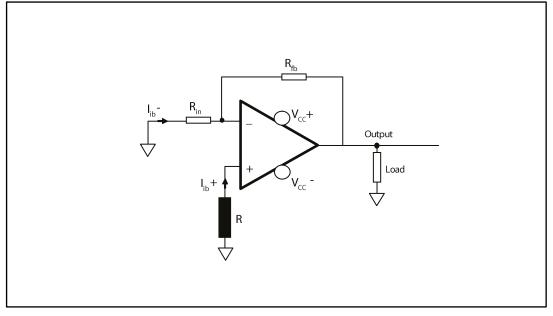
6.4 Bias of an inverting amplifier

A resistance is necessary to achieve good input biasing, such as resistance R shown in *Figure 29*.

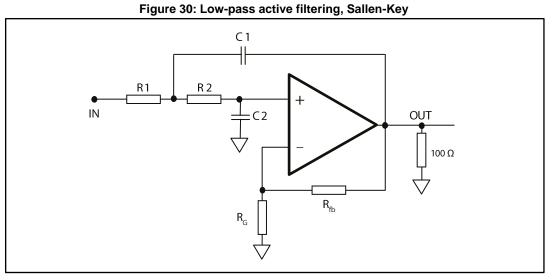
The value of this resistance is calculated from the negative and positive input bias current. The aim is to compensate for the offset bias current, which can affect the input offset voltage and the output DC component. Assuming I_{ib-} , I_{ib+} , R_{in} , R_{fb} and a 0 V output, the resistance R is:

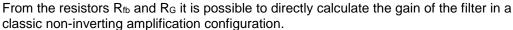
$$\mathsf{R} = \frac{\mathsf{R}_{\mathsf{in}} \cdot \mathsf{R}_{\mathsf{fb}}}{\mathsf{R}_{\mathsf{in}} + \mathsf{R}_{\mathsf{fb}}}$$





6.5 Active filtering





$$A_V = g = 1 + \frac{R_{fb}}{R_g}$$

The response of the system is assumed to be:

$$T_{j\omega} = \frac{Vout_{j\omega}}{Vin_{j\omega}} = \frac{g}{1+2\zeta \frac{j\omega}{\omega_c} + \frac{(j\omega)^2}{{\omega_c}^2}}$$

The cut-off frequency is not gain-dependent and so becomes:

$$\omega_{\rm C} = \frac{1}{\sqrt{\rm R1R2C1C2}}$$

The damping factor is calculated using the following expression.

$$\zeta = \frac{1}{2}\omega_{C}(C_{1}R_{1} + C_{1}R_{2} + C_{2}R_{1} - C_{1}R_{1}g)$$

The higher the gain, the more sensitive the damping factor. When the gain is higher than 1, it is preferable to use very stable resistor and capacitor values. In the case of R1 = R2 = R:

$$\zeta = \frac{2C_2 - C_1 \frac{R_{fb}}{R_g}}{2\sqrt{C_1 C_2}}$$

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Due to a limited selection of capacitor values in comparison with the resistors, you can set C1 = C2 = C, so that:

$$\zeta = \frac{2R_2 - R_1 \frac{R_{fb}}{R_g}}{2\sqrt{R_1R_2}}$$

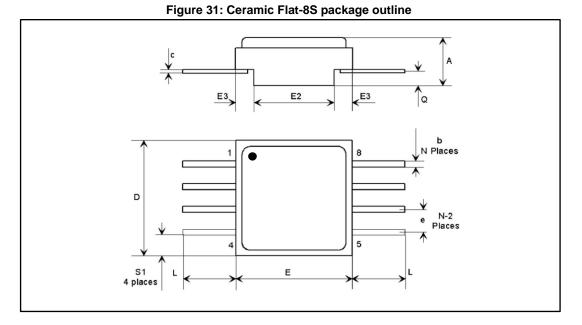


7 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK[®] is an ST trademark.



7.1 Ceramic Flat-8S package information



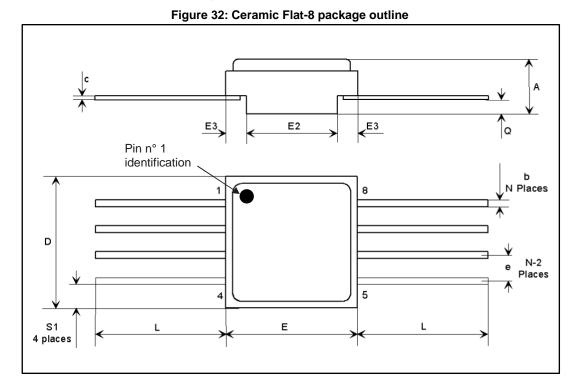


The upper metallic lid is not electrically connected to any pins, nor to the IC die inside the package. Connecting unused pins or metal lid to ground or to the power supply will not affect the electrical characteristics.

	Dimensions									
Ref.		Millimeters		Inches						
	Min.	Тур.	Max.	Min.	Тур.	Max.				
А	2.24	2.44	2.64	0.088	0.096	0.104				
b	0.38	0.43	0.48	0.015	0.017	0.019				
С	0.10	0.13	0.16	0.004	0.005	0.006				
D	6.35	6.48	6.61	0.250	0.255	0.260				
E	6.35	6.48	6.61	0.250	0.255	0.260				
E2	4.32	4.45	4.58	0.170	0.175	0.180				
E3	0.88	1.01	1.14	0.035	0.040	0.045				
е		1.27			0.050					
L		3.00			0.118					
Q	0.66	0.79	0.92	0.026	0.031	0.092				
S1	0.92	1.12	1.32	0.036	0.044	0.052				
Ν		8			8					

Table 7: Ceramic Flat-8S mechanical data





7.2 Ceramic Flat-8 package information



The upper metallic lid is electrically connected to pin 5. No other pin is electrically connected to the metallic lid nor to the IC die inside the package.

	Dimensions								
Ref.		Millimeters		Inches					
	Min.	Тур.	Max.	Min.	Тур.	Max.			
А	2.24	2.44	2.64	0.088	0.096	0.104			
b	0.38	0.43	0.48	0.015	0.017	0.019			
С	0.10	0.13	0.16	0.004	0.005	0.006			
D	6.35	6.48	6.61	0.250	0.255	0.260			
Е	6.35	6.48	6.61	0.250	0.255	0.260			
E2	4.32	4.45	4.58	0.170	0.175	0.180			
E3	0.88	1.01	1.14	0.035	0.040	0.045			
е		1.27			0.050				
L	6.51		7.38	0.256		0.291			
Q	0.66	0.79	0.92	0.026	0.031	0.036			
S1	0.92	1.12	1.32	0.036	0.044	0.052			
Ν		08			08				

Table 8: Ceramic Flat-8 package mechanical data



Ordering information 8

	Table 9: Order codes								
Order code	SMD pin	Quality level	Package	Lead finish	Marking ⁽¹⁾	Packing			
RHF350K1		Engineering model	Flat-8S	Gold	RHF350K1	Strip pack			
RHF350AK1	_		Flat-8						
RHF350K-01V	5000507000		Flat-8S		5962F0723201VXC				
RHF350AK01V	5962F07232	QML-V flight	Flat-8		5962F0723202VYC				

Notes:

 $\ensuremath{^{(1)}}\ensuremath{\mathsf{Specific}}$ marking only. Complete marking includes the following:

- SMD pin (as indicated in above table)
- ST logo

Date code (date the package was sealed) in YYWWA (year, week, and lot index of week)
QML logo (Q or V)

- Country of origin (FR = France).



Contact your ST sales office for information regarding the specific conditions for products in die form and QML-Q versions.



9 Other information

9.1 Date code

The date code is structured as shown below:

- EM xyywwz
- QML-V yywwz
 - where:
 - x (EM only) = 3 and the assembly location is Rennes, France
 - yy = last two digits of the year
 - ww = week digits
 - z = lot index in the week

9.2 Documentation

Table 10: Documentation provided for each type of product

Quality level	Documentation
Engineering model	_
QML-V flight	Certificate of conformance
	QCI (groups A, B, C, D, and E) ⁽¹⁾
	Screening electrical data
	Precap report
	PIND test ⁽²⁾
	SEM inspection report ⁽³⁾
	X-ray report

Notes:

 $^{(1)}QCI$ = quality conformance inspection

 $^{(2)}$ PIND = particle impact noise detection

⁽³⁾SEM = scanning electron microscope



10 Revision history

Table 11: Document revision history		
Date	Revision	Changes
20-May-2009	1	Initial release
12-Jul-2010	2	Added Mass in Features on cover page. Added Table 1: Device summary on cover page, with full ordering information. Changed temperature limits in Table 4: Radiations
27-Jul-2011	3	Added note to the Package information section and in the Pin connections diagram on the coverpage.
03-Aug-2012	4	Updated Table 4: Radiations with values after radiations. Replaced note in the Package information section with a footnote. Minor corrections throughout document.
06-Feb-2015	5	Replaced package name with "Flat-8S" instead of "Flat-8" Replaced package silhouette and added marker to show the position of pin 1 on package silhouette, pinout and drawing. Updated Features Updated Table 1: Device summary Removed Table 4: Radiations from Section 2: Electrical characteristics. Added Section 3: Radiations Added Section 4: Device description and operation and updated document layout accordingly. Updated Section 6: Ordering information Added Section 7: Other information
06-Apr-2016	6	Updated document layout Table 1: "Device summary": updated footnote 1, SMD = standard microcircuit drawing.
05-Apr-2017	7	Added part number RHF350A Replaced cover image Updated <i>Features</i> Updated <i>Applications</i> Updated <i>Description</i> Added Section 1: "Pin description" Table 2: "Absolute maximum ratings": updated Rthja and Rthjc values. Table 4: updated Bw and SR parameters; updated footnote 2. Section 5.2: "Total ionizing dose (TID)": corrected typos Added Section 7.2: "Ceramic Flat-8 package information" Table 9: "Order codes": updated table title, removed column "EPPL", added order codes RHF350AK1 and RHF350AK01V, and updated footnotes.

Table 11: Document revision history



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